

AO4498-VB Datasheet N-Channel 30-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | |
|---------------------|----------------------------------|---------------------------------|-----------------------|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) ^a | Q _g (Typ.) | | |
| 30 | 0.004 at V _{GS} = 10 V | 18 | 6.8 nC | | |
| 30 | 0.005 at V _{GS} = 4.5 V | 16 | 0.0110 | | |

SO-8

Top View

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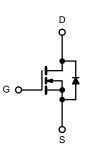
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FEATURES

- Halogen-free
- TrenchFET[®] Power MOSFET
- Optimized for High-Side Synchronous Rectifier Operation
- 100 % R_g Tested
- 100 % UIS Tested

APPLICATIONS

Notebook CPU Core
High-Side Switch



N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS | S T _A = 25 °C, unles | s otherwise no | ted | | |
|--|-----------------------------------|------------------|---------------------|------|------|
| Parameter | | Symbol | Limit | Unit | |
| Drain-Source Voltage | V _{DS} | 30 | - V | | |
| Gate-Source Voltage | | V _{GS} | | | ± 20 |
| | T _C = 25 °C | | 18 | | |
| Continuous Drain Current (T _J = 150 °C) | T _C = 70 °C | | 16 | | |
| Continuous Drain Current (1) = 150°C) | T _A = 25 °C | I _D – | 15 ^{b, c} | ٨ | |
| | T _A = 70 °C | | 13 ^{b, c} | | |
| Pulsed Drain Current | | I _{DM} | 50 | A | |
| Outline Outline Duris Dials Outline | T _C = 25 °C | L. | 3.8 | | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | I _S – | 2.1 ^{b, c} | | |
| Single Pulse Avalanche Current | L _ 0.1 mH | I _{AS} | 22 | | |
| valanche Energy L = 0.1 r | | E _{AS} | 24 | mJ | |
| | T _C = 25 °C | | 4.5 | | |
| Maximum Davias Disainatian | T _C = 70 °C | Б | 2.8 | 14/ | |
| Maximum Power Dissipation | T _A = 25 °C | P _D | 2.5 ^{b, c} | W | |
| | T _A = 70 °C | | 1.6 ^{b, c} | | |
| Operating Junction and Storage Temperature Ra | T _J , T _{stg} | - 55 to 150 | °C | | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|---|--------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^{b, d} | t ≤ 10 s | R _{thJA} | 38 | 50 | °C/W | |
| Maximum Junction-to-Foot (Drain) | Steady State | R _{thJF} | 22 | 28 | 0/11 | |

Notes:

a. Base on T_C = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s. d. Maximum under Steady State conditions is 85 °C/W.



| Symbol | Test Conditions | Min. | Тур. | Max. | 1 Init | |
|-------------------------|---|--|--|--|--|--|
| | | | 1961 | max. | Unit | |
| 1 | | | | T | | |
| V _{DS} | $V_{GS} = 0 V, I_{D} = 250 \mu A$ | 30 | | | V | |
| $\Delta V_{DS}/T_{J}$ | lь = 250 цА | | 28 | | mV/°C | |
| $\Delta V_{GS(th)}/T_J$ | 5 | | - 6 | | | |
| V _{GS(th)} | $V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$ | 1.0 | | 3.0 | V | |
| I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | ± 100 | nA | |
| | $V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | | | 1 | | |
| 'DSS | $V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$ | | | 10 | μΑ | |
| I _{D(on)} | $V_{DS} \ge 5$ V, $V_{GS} = 10$ V | 20 | | | А | |
| Б | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 11 \text{ A}$ | 0.004 | | | | |
| r DS(on) | V _{GS} = 4.5 V, I _D = 10 A | | 0.005 | | Ω | |
| 9 _{fs} | V _{DS} = 15 V, I _D = 11 A | | 52 | | S | |
| 11 | | | | 1 | 4 | |
| C _{iss} | | | 820 | | pF | |
| | V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz | | 195 | | | |
| | 20 00 | | 73 | | | |
| | V _{DS} = 15 V, V _{GS} = 10 V, I _D = 11 A | | 15 | 23 | - | |
| Qg | | | 6.8 | 10.2 | nC | |
| Q _{qs} | V _{DS} = 15 V, V _{GS} = 5 V, I _D = 11 A | | 2.5 | | | |
| Ĵ | | | 2.3 | | | |
| Ĵ. | f = 1 MHz | 0.36 | 1.8 | 3.6 | Ω | |
| <u> </u> | | | 16 | 24 | | |
| t _r | $V_{DD} = 15 \text{ V}, \text{ R}_{1} = 1.4 \Omega$ | | 12 | 18 | - | |
| t _{d(off)} | $I_D \cong 9 \text{ A}, V_{GEN} = 4.5 \text{ V}, \text{ R}_g = 1 \Omega$ | | 16 | 24 | | |
| t _f | | | 10 | 20 | | |
| t _{d(on)} | | | 8 | 16 | ns | |
| t _r | $V_{DD} = 15 \text{ V}, \text{ R}_{1} = 1.4 \Omega$ | | 10 | 20 | - | |
| t _{d(off)} | $I_D \cong 9 \text{ A}, V_{GEN} = 10 \text{ V}, \text{R}_g = 1 \Omega$ | | 16 | 24 | | |
| | - | | 8 | 15 | | |
| | | | | | <u> </u> | |
| | T _C = 25 °C | | | 25 | | |
| I _{SM} | | | | 50 | A | |
| - | I _S = 9 A | | 0.8 | 1.2 | V | |
| | | | 15 | 30 | ns | |
| | | | - | 12 | nC | |
| | $I_F = 9 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$ | | | | | |
| | | | | | ns | |
| | $\begin{array}{c c} \Delta V_{GS(th)}/T_J \\ \hline V_{GS(th)} \\ \hline I_{GSS} \\ \hline I_{DSS} \\ \hline I_{D(on)} \\ \hline R_{DS(on)} \\ \hline g_{fs} \\ \hline \\ \hline \\ C_{iss} \\ \hline \\ C_{css} \\ \hline \\ C_{css} \\ \hline \\ \\ Q_g \\ \hline \\ Q_{gd} \\ \hline \\ \\ Q_{gd} \\ \hline \\ \\ R_g \\ \hline \\ \\ Q_{gd} \\ \hline \\ \\ R_g \\ \hline \\ \\ Q_{gd} \\ \hline \\ \\ R_g \\ \hline \\ \\ (A(on)) \\ \hline \\ t_r \\ \hline \\ t_{d(onf)} \\ \hline \\ t_f \\ \hline \\ t_{d(onf)} \\ \hline \\ t_r \\ \hline \\ t_{d(onf)} \\ \hline \\ t_r \\ \hline \\ t_{d(off)} \\ \hline \\ t_f \\ \hline \\ t_{d(off)} \\ \hline \\ t_f \\ \hline \\ t_{d(off)} \\ \hline \\ t_f \\ \hline \\ t_{f} \\ \hline \\ t_{f} \\ \hline \\ t_{f} \\ \hline \\ t_{f} \\ \hline \\ t_{S} \\ \hline \\ \end{bmatrix} $ | $\begin{array}{ c c c c c c } & I_D = 250 \ \mu A \\ \hline I_D = 250 \ \mu A \\ \hline V_{GS(th)} & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A \\ \hline I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^{\circ}C \\ \hline I_{D(on)} & V_{DS} \ge 5 \ V, \ V_{GS} = 10 \ V \\ \hline V_{DS} = 30 \ V, \ I_D = 11 \ A \\ \hline V_{GS} = 4.5 \ V, \ I_D = 11 \ A \\ \hline V_{GS} = 4.5 \ V, \ I_D = 11 \ A \\ \hline V_{GS} = 4.5 \ V, \ I_D = 11 \ A \\ \hline V_{GS} = 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline C_{rss} & V_{DS} = 15 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline C_{rss} & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 11 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 11 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 11 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 11 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 11 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 11 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 11 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 11 \ A \\ \hline Q_{gd} & I_D \cong 9 \ A, \ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega \\ \hline t_d(on) & t_r & V_{DD} = 15 \ V, \ R_L = 1.4 \ \Omega \\ \hline t_d(off) & I_D \cong 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline t_f & I_D \cong 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline t_f & I_D \cong 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline t_f & I_D \cong 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline t_f & I_D \cong 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline t_f & I_D \cong 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline t_f & I_D \cong 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline t_f & I_D \cong 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline t_f & I_S \ T_C = 25 \ ^{\circ}C \\ \hline I_{SM} & I_F = 9 \ A, \ dI/dt = 100 \ A/\mu S, \ T_J = 25 \ ^{\circ}C \\ \hline t_{SM} & I_F = 9 \ A, \ dI/dt = 100 \ A/\mu S, \ T_J = 25 \ ^{\circ}C \\ \hline t_{SM} & I_S \ T_S \$ | $\begin{array}{ c c c c c c } & I_D = 250 \ \mu A & & & & & \\ \hline I_D = 250 \ \mu A & & & & & & \\ \hline V_{GS(th)} & V_{DS} = V_{GS}, I_D = 250 \ \mu A & & & & & & \\ \hline I_{GSS} & V_{DS} = 0 \ V, V_{GS} = 4 \ 20 \ V & & & & \\ \hline V_{DS} = 30 \ V, V_{GS} = 0 \ V & & & & & \\ \hline V_{DS} = 30 \ V, V_{GS} = 0 \ V & & & & & \\ \hline V_{DS} = 30 \ V, V_{GS} = 0 \ V & & & & & \\ \hline V_{DS} = 30 \ V, V_{GS} = 0 \ V & & & & & \\ \hline V_{DS} = 30 \ V, V_{GS} = 10 \ V & & & & & \\ \hline V_{DS} = 30 \ V, V_{GS} = 10 \ V & & & & & \\ \hline V_{DS} = 30 \ V, V_{GS} = 10 \ V & & & & & \\ \hline V_{DS} = 10 \ V, I_D = 11 \ A & & & & \\ \hline V_{CS} = 15 \ V, I_D = 11 \ A & & & & \\ \hline \hline C_{rss} & & & & \\ \hline \hline C_{rss} & & & & & \\ \hline C_{rss} & & & & & \\ \hline V_{DS} = 15 \ V, V_{GS} = 0 \ V, \ I_D = 11 \ A & & & \\ \hline \hline Q_{g} & & & & & \\ \hline V_{DS} = 15 \ V, V_{GS} = 10 \ V, \ I_D = 11 \ A & & \\ \hline Q_{gd} & & & & \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 11 \ A & & \\ \hline Q_{gd} & & & & \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 11 \ A & & \\ \hline Q_{gd} & & & & \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 5 \ V, \ I_D = 11 \ A & & \\ \hline Q_{gd} & & & & \\ \hline I_D \cong 9 \ A, \ V_{GS} = 5 \ V, \ I_D = 11 \ A & & \\ \hline \hline U_D \cong 9 \ A, \ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega & & \\ \hline I_D \equiv 9 \ A, \ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega & & \\ \hline I_D \equiv 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega & & \\ \hline I_D \equiv 9 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega & & \\ \hline \hline I_T & & & \\ \hline I_S & & & \\ \hline V_{SD} & I_S = 9 \ A & & \\ \hline I_F = 9 \ A, \ dI/dt = 100 \ A/\mu s, \ T_J = 25 \ ^{\circ}C & \\ \hline \hline \hline \end{array}$ | $\begin{array}{ c c c c c c c c c c c c c c c c c c c$ | $\begin{array}{ c c c c c c c c c c c c c c c c c c c$ | |

Notes:

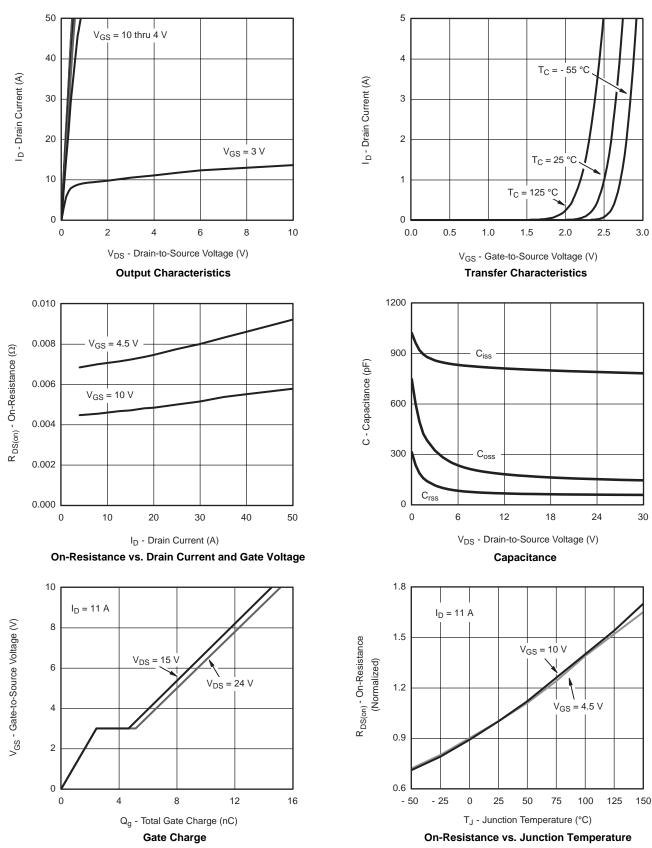
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

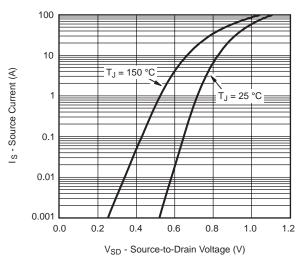




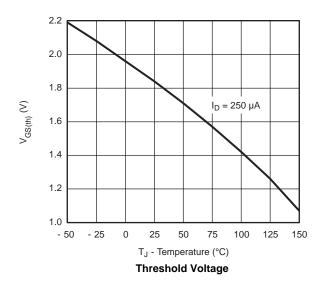


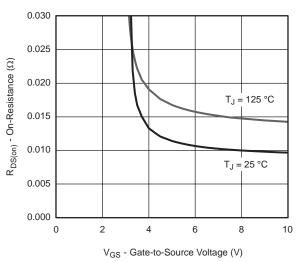


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

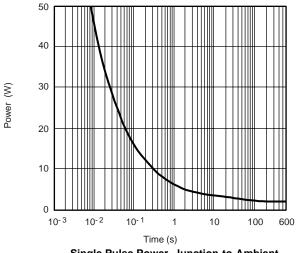




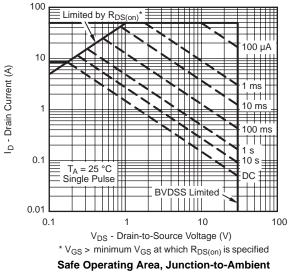




On-Resistance vs. Gate-to-Source Voltage

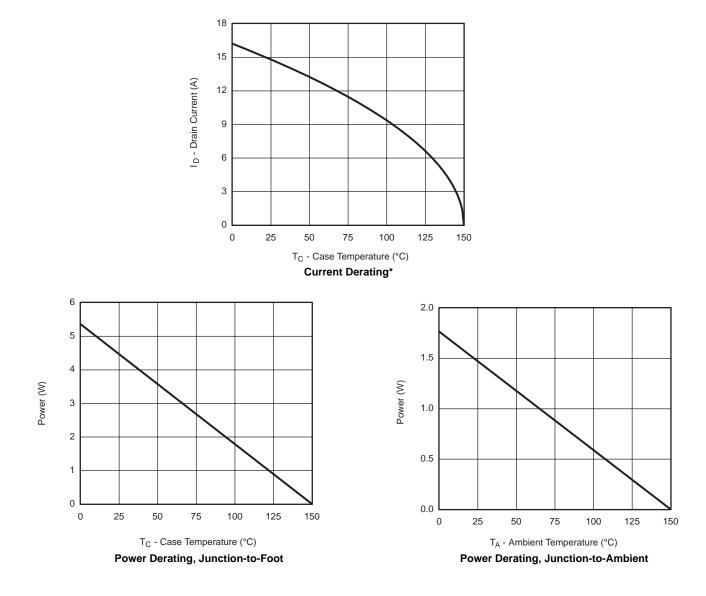


Single Pulse Power, Junction-to-Ambient



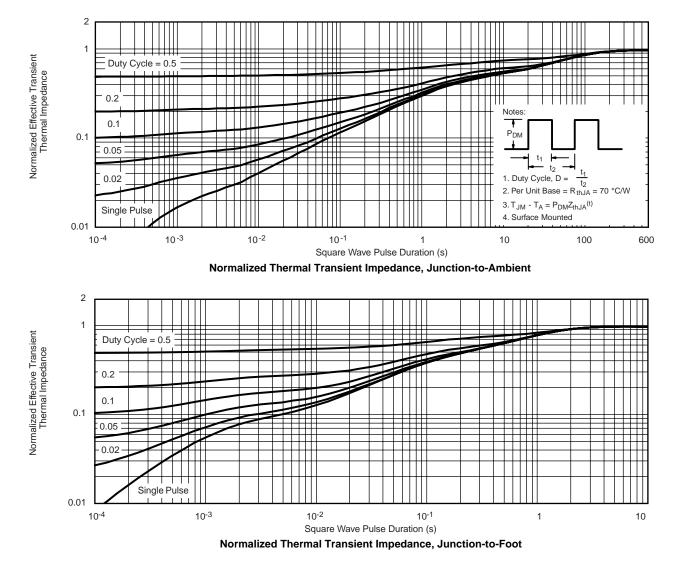


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

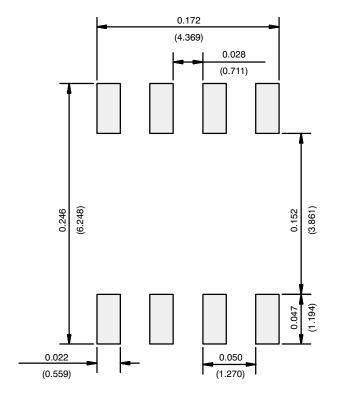




| | MILLIMETERS | | INCHES | | |
|---|-------------|------|-----------|-------|--|
| DIM | Min | Мах | Min | Max | |
| A | 1.35 | 1.75 | 0.053 | 0.069 | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | |
| E | 3.80 | 4.00 | 0.150 | 0.157 | |
| е | 1.27 BSC | | 0.050 BSC | | |
| н | 5.80 | 6.20 | 0.228 | 0.244 | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | |
| q | 0° | 8° | 0° | 8° | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | |
| ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498 | | | | | |



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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